Excellent Integrated System Limited

Stocking Distributor

Click to view price, real time Inventory, Delivery & Lifecycle Information:

ON Semiconductor
NSBA115TDP6T5G

For any questions, you can email us directly:
sales@integrated-circuit.com

Distributor of ON Semiconductor: Excellent Integrated System Limited
Datasheet of NSBA115TDP6T5G - TRANS 2PNP PREBIAS 0.408W SOT963
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

NSBA115TDP6

Dual PNP Bias Resistor Transistors
R1 = 100 kΩ, R2 = ∞ kΩ

PNP Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base-emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C, common for Q_1 and Q_2, unless otherwise noted)

Rating	Symbol	Max	Unit
Collector-Base Voltage	V_{CBO}	50	Vdc
Collector-Emitter Voltage	V_{CEO}	50	Vdc
Collector Current – Continuous	I_C	100	mAdc
Input Forward Voltage	$V_{IN(fwd)}$	40	Vdc
Input Reverse Voltage	$V_{IN(rev)}$	5	Vdc

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ORDERING INFORMATION

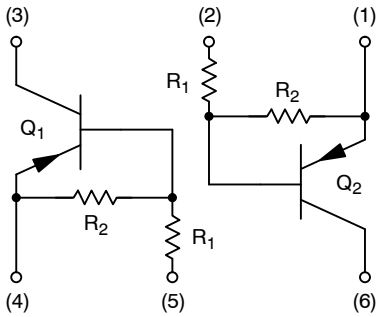
Device	Package	Shipping†
NSBA115TDP6T5G	SOT−963	8,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ON Semiconductor®

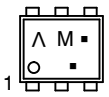
http://onsemi.com

PIN CONNECTIONS



MARKING DIAGRAM

SOT−963
CASE 527AD



V = Specific Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

© Semiconductor Components Industries, LLC, 2012

Distributor of ON Semiconductor: Excellent Integrated System Limited
Datasheet of NSBA115TDP6T5G - TRANS 2PNP PREBIAS 0.408W SOT963
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

THERMAL CHARACTERISTICS

Characteristic		Symbol	Max	Unit
NSBA115TDP6 (SOT−963) ONE JUNCTION HEATED				
Total Device Dissipation T_A = 25°C Derate above 25°C	 (Note 1) (Note 2) (Note 1) (Note 2)	P_D	 231 269 1.9 2.2	 MW mW/°C
Thermal Resistance, Junction to Ambient	 (Note 1) (Note 2)	$R_{\theta JA}$	 540 464	°C/W
NSBA115TDP6 (SOT−963) BOTH JUNCTION HEATED (Note 3)				
Total Device Dissipation T_A = 25°C Derate above 25°C	 (Note 1) (Note 2) (Note 1) (Note 2)	P_D	 339 408 2.7 3.3	 MW mW/°C
Thermal Resistance, Junction to Ambient	 (Note 1) (Note 2)	$R_{\theta JA}$	 369 306	°C/W
Junction and Storage Temperature Range		T_J, T_{stg}	−55 to +150	°C

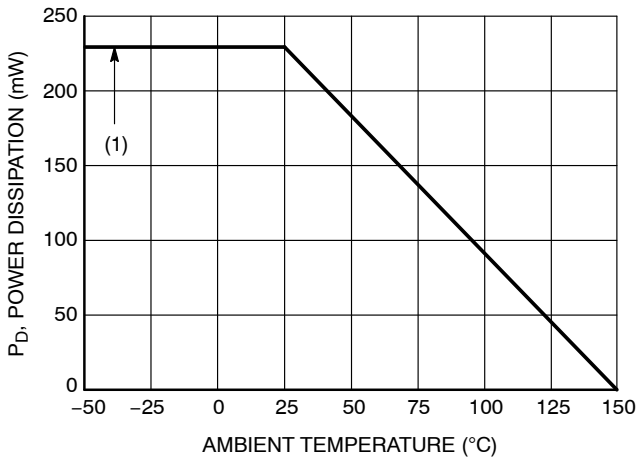
1. FR−4 @ 100 mm^2, 1 oz. copper traces, still air.
2. FR−4 @ 500 mm^2, 1 oz. copper traces, still air.
3. Both junction heated values assume total power is sum of two equally powered channels.

Distributor of ON Semiconductor: Excellent Integrated System Limited
Datasheet of NSBA115TDP6T5G - TRANS 2PNP PREBIAS 0.408W SOT963
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

ELECTRICAL CHARACTERISTICS (T_A = 25°C, common for Q_1 and Q_2, unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS					
Collector-Base Cutoff Current (V_{CB} = 50 V, I_E = 0)	I_{CBO}	–	–	100	nAdc
Collector-Emitter Cutoff Current (V_{CE} = 50 V, I_B = 0)	I_{CEO}	–	–	500	nAdc
Emitter-Base Cutoff Current (V_{EB} = 6.0 V, I_C = 0)	I_{EBO}	–	–	0.1	mAdc
Collector-Base Breakdown Voltage (I_C = 10 μA, I_E = 0)	$V_{(BR)CBO}$	50	–	–	Vdc
Collector-Emitter Breakdown Voltage (Note 4) (I_C = 2.0 mA, I_B = 0)	$V_{(BR)CEO}$	50	–	–	Vdc
ON CHARACTERISTICS					
DC Current Gain (Note 4) (I_C = 5.0 mA, V_{CE} = 10 V)	h_{FE}	160	350	–	
Collector-Emitter Saturation Voltage (Note 4) (I_C = 10 mA, I_B = 0.3 mA)	$V_{CE(sat)}$	–	–	0.25	V
Input Voltage (Off) (V_{CE} = 5.0 V, I_C = 100 μA)	$V_{i(off)}$	–	0.62	–	Vdc
Input Voltage (On) (V_{CE} = 0.2 V, I_C = 1.0 mA)	$V_{i(on)}$	–	1.0	–	Vdc
Output Voltage (On) (V_{CC} = 5.0 V, V_B = 2.5 V, R_L = 1.0 kΩ)	V_{OL}	–	–	0.2	Vdc
Output Voltage (Off) (V_{CC} = 5.0 V, V_B = 0.5 V, R_L = 1.0 kΩ)	V_{OH}	4.9	–	–	Vdc
Input Resistor	R1	70	100	130	kΩ
Resistor Ratio	R_1/R_2	–	–	–	

4. Pulsed Condition: Pulse Width = 300 ms, Duty Cycle ≤ 2%.



(1) SOT−963; 100 mm^2, 1 oz. Copper Trace

Figure 1. Derating Curve

TYPICAL CHARACTERISTICS
NSBA115TDP6

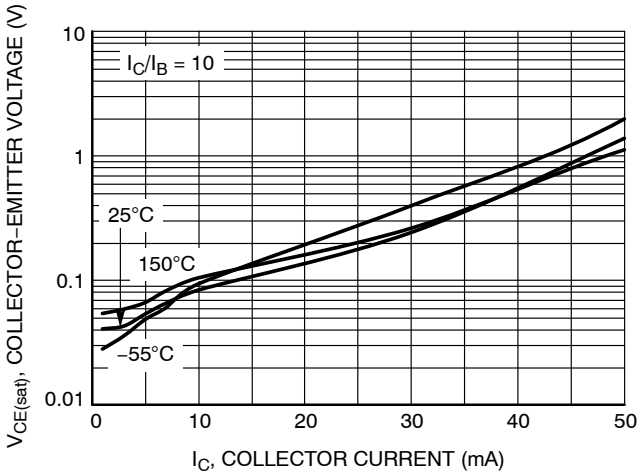


Figure 2. $V_{CE(sat)}$ vs. I_C

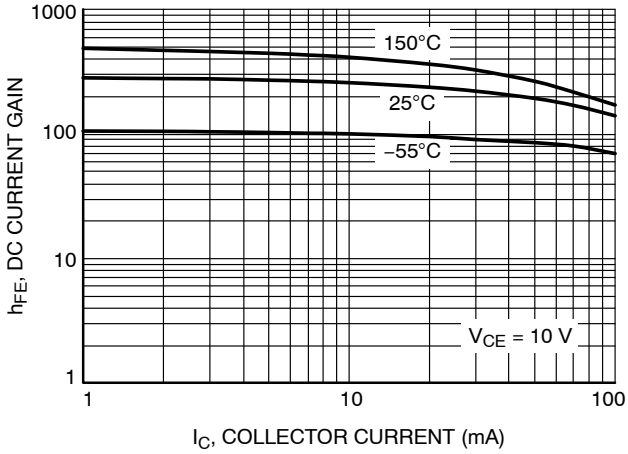


Figure 3. DC Current Gain

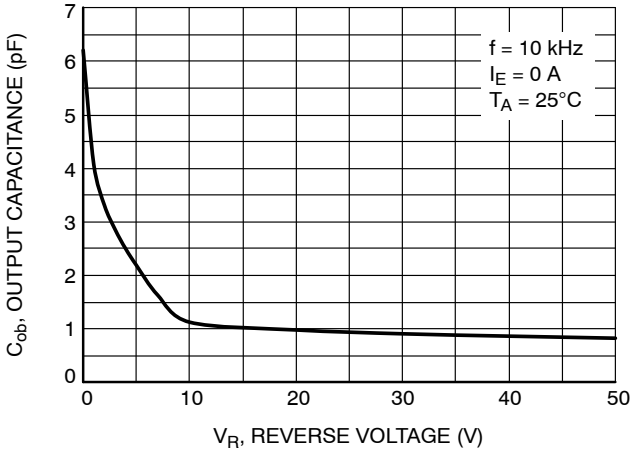


Figure 4. Output Capacitance

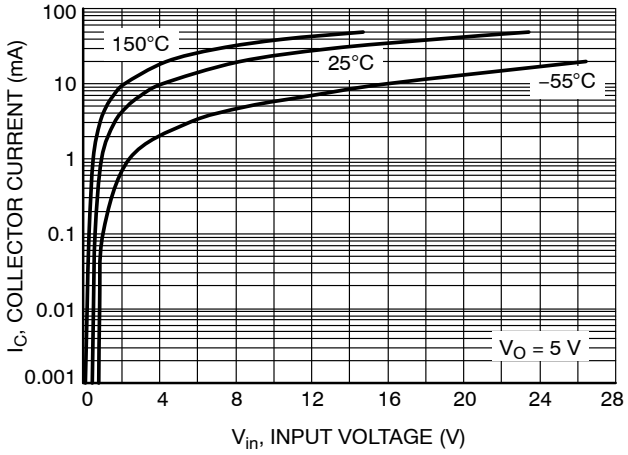


Figure 5. Output Current vs. Input Voltage

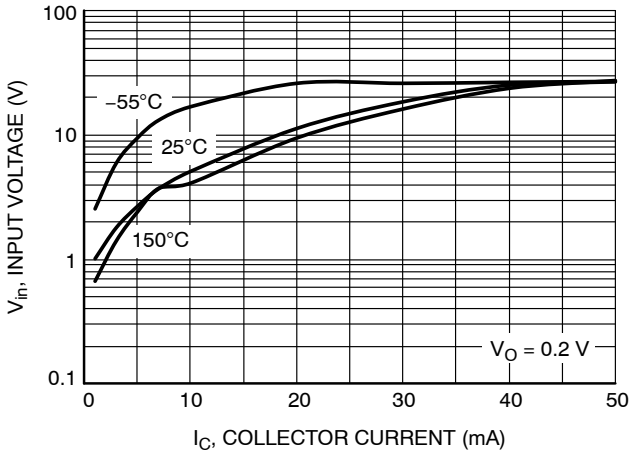


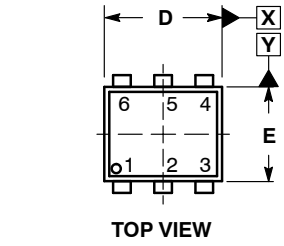
Figure 6. Input Voltage vs. Output Current

Distributor of ON Semiconductor: Excellent Integrated System Limited
Datasheet of NSBA115TDP6T5G - TRANS 2PNP PREBIAS 0.408W SOT963
Contact us: sales@integrated-circuit.com Website: www.integrated-circuit.com

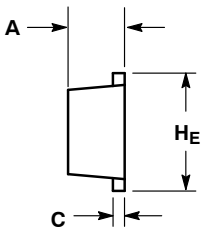
NSBA115TDP6

PACKAGE DIMENSIONS

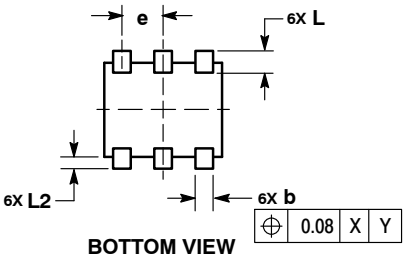
SOT−963
CASE 527AD
ISSUE E



TOP VIEW



SIDE VIEW

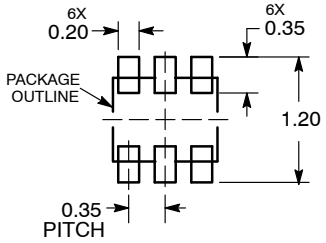


BOTTOM VIEW

NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS		
DIM	MIN	NOM	MAX
A	0.34	0.37	0.40
b	0.10	0.15	0.20
C	0.07	0.12	0.17
D	0.95	1.00	1.05
E	0.75	0.80	0.85
e		0.35 BSC	
HE	0.95	1.00	1.05
L		0.19 REF	
L2	0.05	0.10	0.15

RECOMMENDED MOUNTING FOOTPRINT*



DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and ON are registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent−Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
Fax: 303−675−2176 or 800−344−3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800−282−9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81−3−5817−1050

ON Semiconductor Website: **www.onsemi.com**

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative